1.5 A, 3.3 V Fixed Linear Regulator

The CS52015–3 linear regulator provides 1.5 A @ 3.3 V reference at 1.0 A with an output voltage accuracy of $\pm 1.5\%$.

The regulator is intended for use as a post regulator and microprocessor supply. The fast loop response and low dropout voltage make this regulator ideal for applications where low voltage operation and good transient response are important.

The circuit is designed to operate with dropout voltages less than 1.4 V at 1.5 A output current. The maximum quiescent current is only 10 mA at full load. Device protection includes over-current and thermal shutdown.

The CS52015–3 is pin compatible with the LT1086 family of linear regulators but has lower dropout voltage.

The regulator is available in TO-220-3, surface mount D²PAK-3, and SOT-223 packages.

Features

- Output Current to 1.5 A
- Output Accuracy to ±1.5% Over Temperature
- Dropout Voltage (typical) 1.05 V @ 1.5 A
- Fast Transient Response
- Fault Protection
 - Current Limit
 - Thermal Shutdown

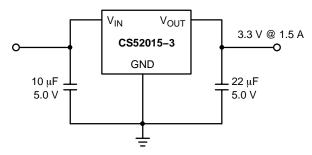
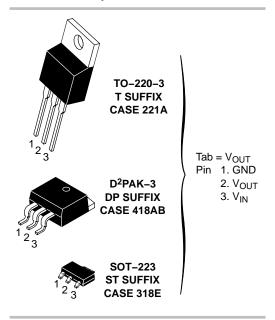


Figure 1. Applications Diagram



ON Semiconductor®

http://onsemi.com



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 6 of this data sheet.

CS52015-3

MAXIMUM RATINGS*

Parameter	Value	Unit
Supply Voltage, V _{IN}	7.0	V
Operating Temperature Range	-40 to +70	°C
Junction Temperature	150	°C
Storage Temperature Range	-60 to +150	°C
Lead Temperature Soldering: Wave Solder (through hole styles only) Note 1 Reflow (SMD styles only) Note 2	260 Peak 230 Peak	°C °C
ESD Damage Threshold	2.0	kV

- 1. 10 second maximum.
- 2. 60 second maximum above 183°C

ELECTRICAL CHARACTERISTICS (C_{IN} = 10 μ F, C_{OUT} = 22 μ F Tantalum, V_{OUT} + $V_{DROPOUT}$ < V_{IN} < 7.0 V, 0°C \leq T_A \leq 70°C, T_J \leq +150°C, unless otherwise specified, I_{full load} = 1.5 A)

Characteristic	Test Conditions	Min	Тур	Max	Unit	
Fixed Output Voltage						
Output Voltage (Notes 3 and 4)	$V_{IN} - V_{OUT} = 1.5 \text{ V};$ $0 \le I_{OUT} \le 1.5 \text{ A}$	3.250 (-1.5%)	3.300	3.350 (+1.5%)	V	
Line Regulation	$2.0 \text{ V} \le \text{V}_{\text{IN}} - \text{V}_{\text{OUT}} \le 3.7 \text{ V}; \text{I}_{\text{OUT}} = 10 \text{ mA}$	-	0.02	0.20	%	
Load Regulation (Notes 3 and 4)	$V_{IN} - V_{OUT} = 2.0 \text{ V}; 10 \text{ mA} \le I_{OUT} \le 1.5 \text{ A}$	-	0.04	0.4	%	
Dropout Voltage (Note 5)	I _{OUT} = 1.5 A	-	1.05	1.4	V	
Current Limit	V _{IN} – V _{OUT} = 3.0 V	1.6	3.1	_	Α	
Quiescent Current	I _{OUT} = 10 mA	-	5.0	10	mA	
Thermal Regulation (Note 6)	30 ms Pulse, T _A = 25°C	_	0.002	0.020	%/W	
Ripple Rejection (Note 6)	f = 120 Hz; I _{OUT} = 1.5 A; V _{IN} – V _{OUT} = 3.0 V; V _{RIPPLE} = 1.0 V _{PP}	-	80	-	dB	
Thermal Shutdown (Note 7)	-	150	180	210	°C	
Thermal Shutdown Hysteresis (Note 7)	-	-	25	-	°C	

- 3. Load regulation and output voltage are measured at a constant junction temperature by low duty cycle pulse testing. Changes in output voltage due to temperature changes must be taken into account separately.
- 4. Specifications apply for an external Kelvin sense connection at a point on the output pin 1/4" from the bottom of the package.
- 5. Dropout voltage is a measurement of the minimum input/output differential at full load.
- 6. Guaranteed by design, not 100% tested in production.
- 7. Thermal shutdown is 100% functionally tested in production.

PACKAGE PIN DESCRIPTION

Pack	age Pin Nur	nber		
TO-220-3	D ² PAK-3	SOT-223	Pin Symbol	Function
1	1	1	GND	Ground connection.
2	2	2	V _{OUT}	Regulated output voltage (case).
3	3	3	V _{IN}	Input voltage.

^{*}The maximum package power dissipation must be observed.

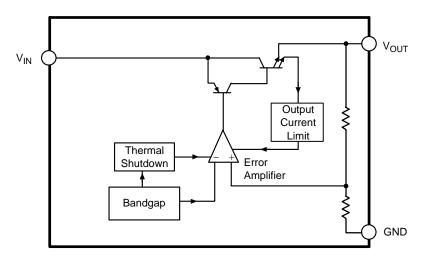
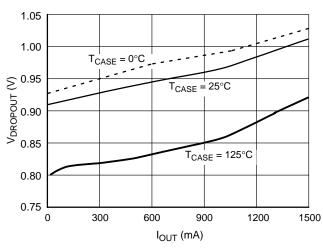


Figure 2. Block Diagram

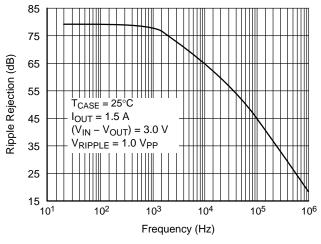
TYPICAL PERFORMANCE CHARACTERISTICS



0.10 0.08 %) 0.06 0.04 0.02 0.00 0.0

Figure 3. Dropout Voltage vs. Output Current

Figure 4. Output Voltage vs. Temperature



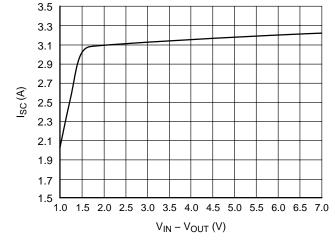
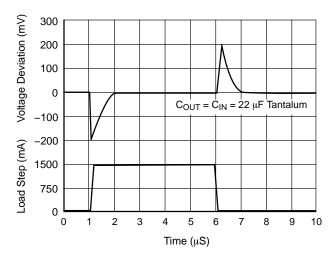


Figure 5. Ripple Rejection vs. Frequency

Figure 6. Short Circuit Current vs. $\label{eq:Vin-Vout} V_{IN} - V_{OUT}$





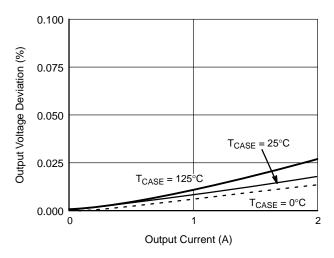


Figure 8. Load Regulation vs. Output
Current

APPLICATIONS INFORMATION

The CS52015–3 linear regulator provides a 3.3 V output voltage at currents up to 1.5 A. The regulator is protected against overcurrent conditions and includes thermal shutdown.

The CS52015–3 has a composite PNP–NPN output transistor and requires an output capacitor for stability. A detailed procedure for selecting this capacitor is included in the Stability Considerations section.

Stability Considerations

The output compensation capacitor helps determine three main characteristics of a linear regulator: start—up delay, load transient response, and loop stability.

The capacitor value and type is based on cost, availability, size and temperature constraints. A tantalum or aluminum electrolytic capacitor is best, since a film or ceramic capacitor with almost zero ESR can cause instability. The aluminum electrolytic capacitor is the least expensive solution. However, when the circuit operates at low temperatures, both the value and ESR of the capacitor will vary considerably. The capacitor manufacturer's data sheet provides this information.

A 22 μF tantalum capacitor will work for most applications, but with high current regulators such as the CS52015–3 the transient response and stability improve with higher values of capacitance. The majority of applications for this regulator involve large changes in load current so the output capacitor must supply the instantaneous load current. The ESR of the output capacitor causes an immediate drop in output voltage given by:

$$\Delta V = \Delta I \times ESR$$

For microprocessor applications it is customary to use an output capacitor network consisting of several tantalum and ceramic capacitors in parallel. This reduces the overall ESR and reduces the instantaneous output voltage drop under transient load conditions. The output capacitor network should be as close to the load as possible for the best results.

Protection Diodes

When large external capacitors are used with a linear regulator it is sometimes necessary to add protection diodes. If the input voltage of the regulator gets shorted, the output capacitor will discharge into the output of the regulator. The discharge current depends on the value of the capacitor, the output voltage and the rate at which $V_{\rm IN}$ drops. In the CS52015–3 linear regulator, the discharge path is through a large junction and protection diodes are not usually needed. If the regulator is used with large values of output capacitance and the input voltage is instantaneously shorted to ground, damage can occur. In this case, a diode connected as shown in Figure 9 is recommended.

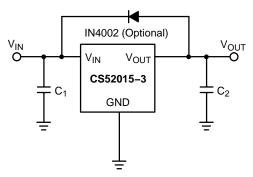


Figure 9. Protection Diode Scheme for Large Output Capacitors

Output Voltage Sensing

Since the CS52015–3 is a three terminal regulator, it is not possible to provide true remote load sensing. Load regulation is limited by the resistance of the conductors connecting the regulator to the load. For best results the regulator should be connected as shown in Figure 10.

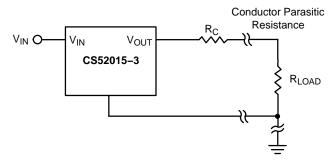


Figure 10. Conductor Parasitic Resistance Effects
Can Be Minimized With the Above Grounding
Scheme For Fixed Output Regulators

Calculating Power Dissipation and Heat Sink Requirements

The CS52015–3 linear regulator includes thermal shutdown and current limit circuitry to protect the device. High power regulators such as these usually operate at high junction temperatures so it is important to calculate the power dissipation and junction temperatures accurately to ensure that an adequate heat sink is used.

The case is connected to V_{OUT} on the CS52015–3, electrical isolation may be required for some applications. Thermal compound should always be used with high current regulators such as these.

The thermal characteristics of an IC depend on the following four factors:

- 1. Maximum Ambient Temperature T_A (°C)
- 2. Power dissipation P_D (Watts)
- 3. Maximum junction temperature T_J (°C)
- 4. Thermal resistance junction to ambient $R_{\theta JA}$ (°C/W)

These four are related by the equation

$$T_{J} = T_{A} + P_{D} \times R_{\Theta J A} \tag{1}$$

The maximum ambient temperature and the power dissipation are determined by the design while the maximum junction temperature and the thermal resistance depend on the manufacturer and the package type.

The maximum power dissipation for a regulator is:

$$PD(max) = \{VIN(max) - VOUT(min)\}IOUT(max) + VIN(max)IQ$$
(2)

where:

V_{IN(max)} is the maximum input voltage,

V_{OUT(min)} is the minimum output voltage,

 $I_{OUT(max)}$ is the maximum output current, for the application

 I_Q is the maximum quiescent current at $I_{OUT(max)}$.

A heat sink effectively increases the surface area of the package to improve the flow of heat away from the IC and into the surrounding air.

Each material in the heat flow path between the IC and the outside environment has a thermal resistance. Like series electrical resistances, these resistances are summed to determine $R_{\theta JA}$, the total thermal resistance between the junction and the surrounding air.

- 1. Thermal Resistance of the junction to case, $R_{\theta JC}$ (°C/W)
- 2. Thermal Resistance of the case to Heat Sink, $R_{\theta CS}$ (°C/W)
- 3. Thermal Resistance of the Heat Sink to the ambient air, $R_{\theta SA}$ (°C/W)

These are connected by the equation:

$$R_{\Theta,JA} = R_{\Theta,JC} + R_{\Theta,CS} + R_{\Theta,SA}$$
 (3)

The value for $R_{\theta JA}$ is calculated using equation (3) and the result can be substituted in equation (1).

The value for $R_{\theta JC}$ is 3.5°C/W for a given package type based on an average die size. For a high current regulator such as the CS52015-3 the majority of the heat is generated in the power transistor section. The value for $R_{\theta SA}$ depends on the heat sink type, while $R_{\theta CS}$ depends on factors such as package type, heat sink interface (is an insulator and thermal grease used?), and the contact area between the heat sink and the package. Once these calculations are complete, the maximum permissible value of $R_{\theta JA}$ can be calculated and the proper heat sink selected. For further discussion on heat "Thermal selection, see application note Management," document number AND8036/D, available through the Literature Distribution Center or via our website at http://onsemi.com.

CS52015-3

ADDITIONAL ORDERING INFORMATION

Orderable Part Number	Type*	Package	Shipping [†]
CS52015-3GT3	1.5 A, 3.3 V Output	TO-220-3, STRAIGHT	50 Units / Rail
CS52015-3GDP3	1.5 A, 3.3 V Output	D ² PAK-3	50 Units / Rail
CS52015-3GDPR3	1.5 A, 3.3 V Output	D ² PAK-3	750 / Tape & Reel
CS52015-3GST3	1.5 A, 3.3 V Output	SOT-223	80 Units / Rail
CS52015-3GSTR3	1.5 A, 3.3 V Output	SOT-223	2500 / Tape & Reel

^{*}Consult your local sales representative for other fixed output voltage versions.

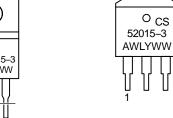
MARKING DIAGRAMS

TO-220-3 T SUFFIX CASE 221A





52015



A = Assembly Location

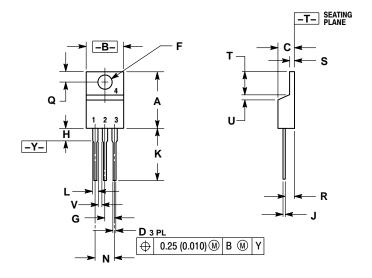
WL, L = Wafer Lot YY, Y = Year

WW, W = Work Week

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

TO-220-3 **T SUFFIX** CASE 221A-08 **ISSUE AA**



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

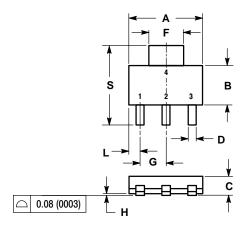
	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.560	0.625	14.23	15.87	
В	0.380	0.420	9.66	10.66	
С	0.140	0.190	3.56	4.82	
D	0.025	0.035	0.64	0.89	
F	0.139	0.155	3.53	3.93	
G	0.100	BSC	2.54 BSC		
Н		0.280		7.11	
7	0.012	0.045	0.31	1.14	
K	0.500	0.580	12.70	14.73	
L	0.045	0.060	1.15	1.52	
N	0.200	BSC	5.08 BSC		
Q	0.100	0.135	2.54	3.42	
R	0.080	0.115	2.04	2.92	
S	0.020	0.055	0.51	1.39	
Т	0.235	0.255	5.97	6.47	
U	0.000	0.050	0.00	1.27	
٧	0.045		1.15		

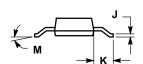
D²PAK-3 **DP SUFFIX** CASE 418AB-01 ISSUE O

For D²PAK Outline and **Dimensions – Contact Factory**

CS52015-3

SOT-223 ST SUFFIX CASE 318E-04 ISSUE K





NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M. 1982.
- 2. CONTROLLING DIMENSION: INCH.

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.249	0.263	6.30	6.70	
В	0.130	0.145	3.30	3.70	
С	0.060	0.068	1.50	1.75	
D	0.024	0.035	0.60	0.89	
F	0.115	0.126	2.90	3.20	
G	0.087	0.094	2.20	2.40	
Н	0.0008	0.0040	0.020	0.100	
J	0.009	0.014	0.24	0.35	
K	0.060	0.078	1.50	2.00	
L	0.033	0.041	0.85	1.05	
M	0°	10 °	0 °	10 °	
S	0.264	0.287	6.70	7.30	

PACKAGE THERMAL DATA

Parameter		TO-220-3	D ² PAK-3	SOT-223	Unit
$R_{\theta JC}$	Typical	3.5	3.5	15	°C/W
$R_{\theta JA}$	Typical	50	10–50*	156	°C/W

^{*} Depending on thermal properties of substrate. $R_{\theta JA}$ = $R_{\theta JC}$ + $R_{\theta CA}$

ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA

Phone: 303–675–2175 or 800–344–3860 Toll Free USA/Canada **Fax**: 303–675–2176 or 800–344–3867 Toll Free USA/Canada **Email**: orderlit@onsemi.com

N. American Technical Support: 800–282–9855 Toll Free LISA/Canada

Japan: ON Semiconductor, Japan Customer Focus Center 2–9–1 Kamimeguro, Meguro–ku, Tokyo, Japan 153–0051 Phone: 81–3–5773–3850

ON Semiconductor Website: http://onsemi.com

Order Literature: http://www.onsemi.com/litorder

For additional information, please contact your local Sales Representative.